

Hunt Electronic Co., Ltd.

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Date: SEP, 27, 2007

Dear Madam / Sir.

We declare that all of EMI suppression parts added on the EUT, FCC ID: UTBHLC-81XW will be put on mass production product.

(A) C810A110.PCB (Main IC circuit board Is Including LAN)

1. Respective connecting 22pF capacitance in parallels from No. 1, 3, 4 and 6 pins of LAN port to GND.
2. Changing RS14 of circuit board to 33-ohm resistance and connecting a bead in series, which its impedance is 70-ohm.
3. Respective connecting 68pF capacitance in parallels to C5, C7 and C8 of circuit board.
4. Connecting 33pF capacitance to C10 in parallels.
5. Connecting a bead to the RS17 of circuit board in series, which its impedance is 80-ohm.
6. Adding conductive shielding gasket to LAN port of circuit board to touch the iron case.

WL-3002-1A Mini PCI

1. On the 2.4GHz emission circuit, respective connecting 68pF capacitance in the front and rear of a bead in parallels, which its impedance is 120-ohm.

C810Z110.PCB (The circuit board Is up the main circuit board)

1. Adding a core on IRIS cable.
2. Connecting 120-ohm bead to No.1 pin of CN3 in series.
3. Respective connecting 22pF capacitance in parallels from No.2 and 3 pin of CN3 to GND.
4. Connecting 0.1uF capacitance in parallels from No. 1 pin of CN1 to GND.
5. Adding a core to the wire circuit, which connects SD Card board.

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C810B110.PCB (Board of POWER and Video out)

1. Connecting 0.1uF capacitance in parallel from CN3 to GND.
2. Connecting 0.1uF capacitance in parallel from No.1 of J4 to GND.
3. Connecting 1000pF capacitance in parallel from BNC1 to GND.
4. Connecting 1000pF capacitance in parallel from RCA1 to GND.

C810E110.PCB (SD Card Read Board)

1. Respective connecting 120-ohm bead in series from No. 3 and 6 pins of J1 to GND.
2. Connecting 68pF capacitance to No.5 pin of J1 in parallel.
3. Changing CB1 of circuit board to 0.1uF capacitance.
4. Changing the L1 to 150-ohm bead.

(B) Mount one suppression core on adaptor power cord.

Sincerely,

*Assistant Vice President
R&D Dept.* *Shu-Shing Lin*